

## ZIITEK ELECTRONIC MATERIAL & TECHNOLOGY CO., LTD

TIF<sup>™</sup>100-07S Thermally Conductive Gap Filler Pads Series

REV02



## **Features**

- » Good thermal conductivity: 1.5 W/mK
- » Naturally tacky needing no further adhesive coating
- » Soft and Compressible for low stress applications
- » Available in varies thickness

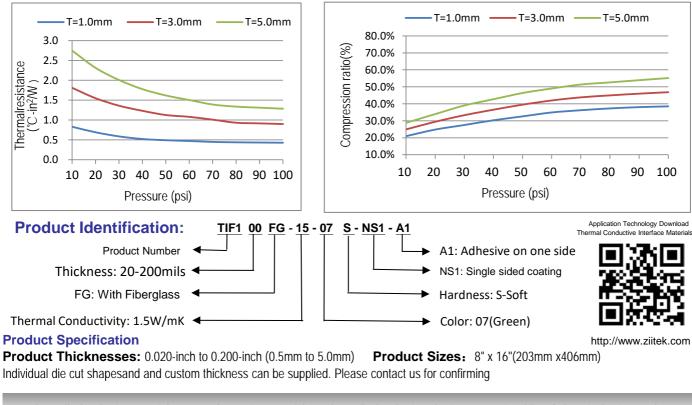
## Application

- » Cooling components to the chassis of frame
- » Set Top Box
- » Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting
- » Graphics Card Thermal Module

TIF<sup>™</sup>100-07S Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effecitly enhances the efficiency and life-time of the heat-generating electronic components.

	Typical Properties of TIF <sup>™</sup> 100-07S Series		
	Color	Green	Visual
	Construction	Ceramic filled silicone elastomer	******
ures of thermal conductivity: <b>1.5 W/mK</b> urally tacky needing no further esive coating and Compressible for low stress lications ilable in varies thickness	Thickness range	0.020"(0.5mm)~0.200" (5.0mm)	ASTM D374
	Hardness	45 Shore 00	ASTM 2240
	Specific Gravity	2.3 g/cc	ASTM D297
	Operating Temp	-40 ~160 °C	******
	Dielectric Breakdown Voltage	>5500 VAC	ASTM D149
ication ling components to the ssis of frame Top Box Battery & Power Supply rging Pile OTV/ Lighting phics Card Thermal Module	Dielectric Constant@1MHz	4.5 MHz	ASTM D150
	Volume Resistivity	1.0X10 <sup>12</sup> Ohm-cm	ASTM D257
	Thermal Conductivity	1.5 W/mK	ASTM D5470
		1.5 W/mK	GB-T32064
	Outgassing (TML)	0.35%	ASTM E595
	Flame Rating	94 -V0	UL E331100
psi. vs. Thermal Resistance psi. vs. Compression Ratio			

## psi. vs. Compression Ratio



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